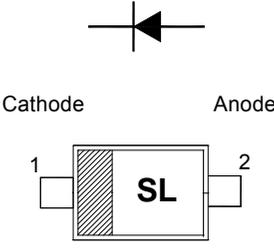


Schottky Diode	
<p>SOD-523</p>  <p>Marking : SL</p>	<p>Features</p> <ul style="list-style-type: none"> ◇ Low Forward Voltage Drop ◇ SOD523 Micro SMD package ◇ RoHS compliant / Green EMC ◇ Matte Tin (Sn) Lead finish ◇ Cathode Band / Device marking ◇ Surface Mount Package Ideally Suited for Automatic Insertion

Maximum Ratings (Ta = 25 °C)

Symbol	Parameter	Value	Units
V _{RRM}	Repetitive Peak Reverse Voltage	40	V
I _{F(AV)}	Average Forward Rectified Current	1	A
I _{FSM}	Non-Repetitive Peak Forward Surge Current (@t=8..3ms)	6	A
T _J	Operating Junction Temperature	125	°C
T _{STG}	Storage Temperature Range	-50 to +125	°C

Electrical Characteristics (Ta = 25 °C)

Symbol	Parameter	Conditions	Min	Max	Units
V _F	Forward Voltage	I _F = 0.3A		0.5	V
		I _F = 1A		0.68	V
I _R	Reverse current	V _R = 40V		100	uA
V _{BR}	Reverse breakdown voltage	I _R = 0.5mA	40		V
C _T	Capacitance	V _R = 0V, f = 1MHz		100	pF

Typical Electrical and Thermal Characteristics (Curves)

Fig. 1 - Forward Current Derating Curve

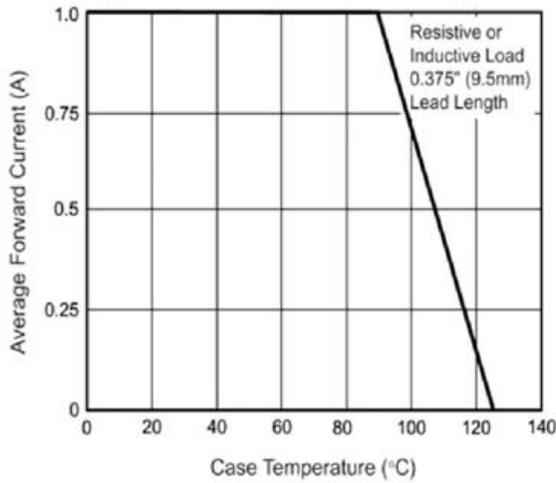


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

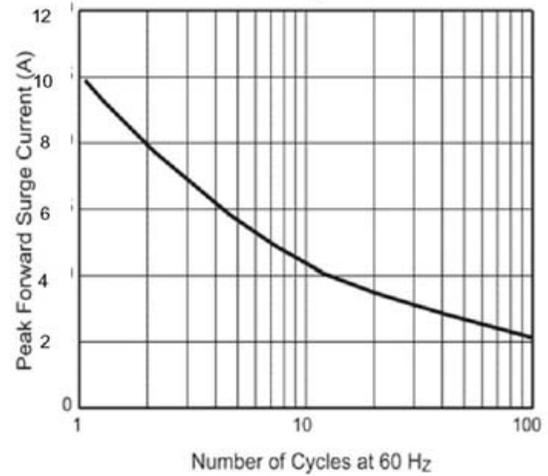


Fig. 3 - Typical Instantaneous Forward Characteristics

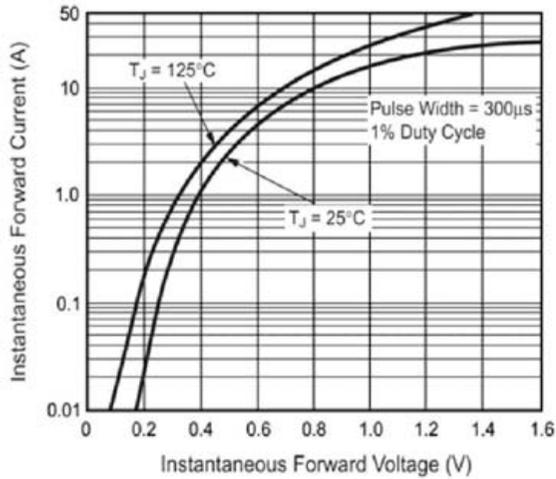


Fig. 4 - Typical Reverse Characteristics

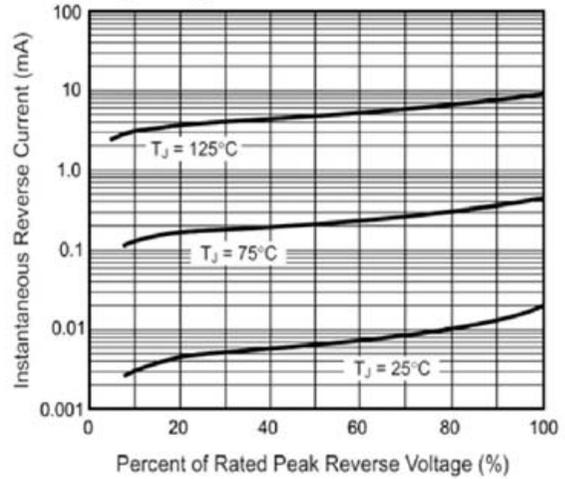


Fig. 5 - Typical Junction Capacitance

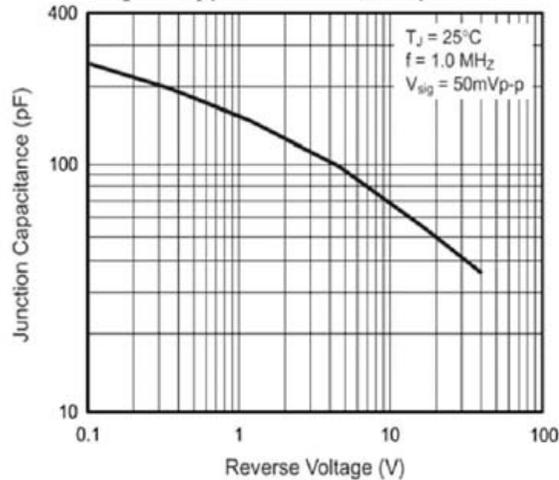
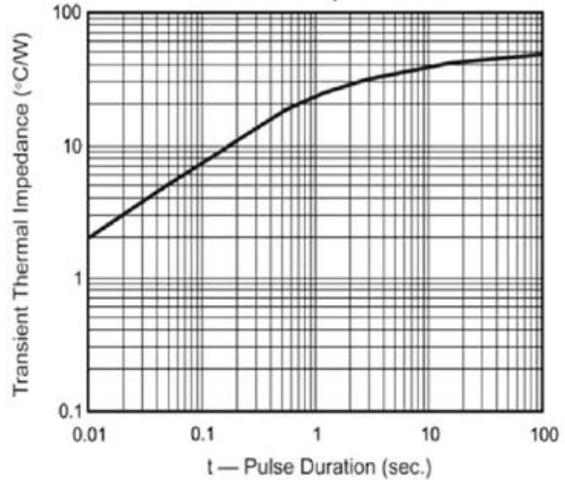


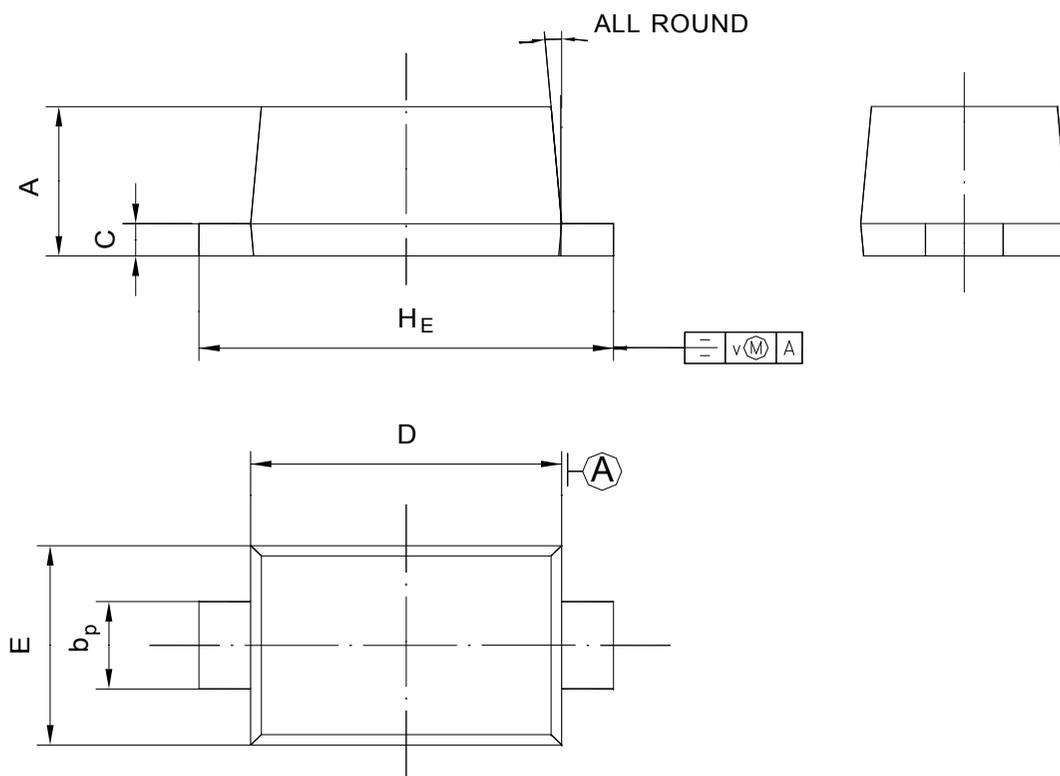
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-523



UNIT	A	b_p	C	D	E	H_E	V	\angle
mm	0.68 0.58	0.4 0.3	0.135 0.100	1.25 1.15	0.85 0.75	1.7 1.5	0.1	5°